3 February 2004 Updated Sparch 09/825,648

_13 Febi	ruary 2004	Updated Sparch		09 1825,648
L Number	Hits	Search Text	DB	Time stamp
-	6	(("6017437") or ("6183611") or ("6241825")).PN.	USPAT;	2003/04/23
			US-PGPUB;	12:26
	.*		EPO; JPO;	
			DERWENT	
-	17	("3826558" "4086870" "5000827" "5024746"	USPAT	2003/04/23
	1	"5095848" "5256274" "5368711" "5429733"		11:56
		"5437777" "5441629" "5447615" "5516414"		
		"5830805" "5853559" "5885353" "5891251"		
		"6019164").PN.		
-	2473	205/118,122,123,125,295,640.ccls. or	USPAT;	2003/04/23
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB,	12:27
			EPO; JPO;	
			DERWENT	
_	2	(205/118,122,123,125,295,640.ccls. or	USPAT;	2003/04/23
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB;	12:31
) and ((chuck or (wafer adj support) or platen or	EPO; JPO;	
		platform) near (adjustable or compliant or resilient or	DERWENT	
		deformable or tiltable))		
-	7	(205/118,122,123,125,295,640.ccls. or	USPAT;	2003/04/23
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB;	12:36
	,) and ((chuck or (wafer adj support) or platen or	EPO; JPO;	
		platform or support) near (adjustable or compliant or	DERWENT	
		resilient or deformable or tiltable))		
-	686	(205/118,122,123,125,295,640.ccls. or	USPAT;	2003/04/23
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB;	12:40
	l ·) and (wafer or microelectronic or semiconductor)	EPO; JPO;	
			DERWENT	
-	8	(205/118,122,123,125,295,640.ccls. or	USPAT;	2004/02/13
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB;	13:40
) and ((chuck or (wafer adj support) or platen or	EPO; JPO;	
		platform or support) near (adjustable or compliant or	DERWENT	
1	j i	resilient or deformable or tiltable or conformable or		
	50,00	conforming))		
-	58692	204/\$.ccls.	USPAT;	2003/04/23
	-		US-PGPUB;	12:39
		·	EPO; JPO;	
	70	204/ft - ale - and //alexaltrass/ - / - 1/2 1/2	DERWENT	2004/00/5
_	70	204/\$.ccls. and ((chuck or (wafer adj support) or	USPAT;	2004/02/13
		platen or platform or support) near (adjustable or	US-PGPUB;	13:53
		compliant or resilient or deformable or tiltable or conformable or conforming))	EPO; JPO; DERWENT	
	7	6019164.URPN.	USPAT	2003/04/23
-	'	OUIZIUT.UKFIN.	USFAI	2003/0 4 /23 12:45
	30	(("5891251") or ("5885353") or ("5830805") or	USPAT;	2003/08/13
	30	((5691231) or (5663333) or (5630603) or (5516414") or ("5447615") or ("5441629") or	US-PGPUB;	13:48
		("5437777") or ("5429733") or ("5368711") or	EPO; JPO;	13.40
		("5256274") or ("5095848") or ("5024746") or	DERWENT;	
		("5000827") or ("4086870") or ("3826558")).PN.	IBM_TDB	
		(300002/) or (40000/0) or (3020330)).PN.	TRW I DR	

	12	((205/118,122,123,125,295,640.ccls. or	USPAT;	2004/02/13
		204/297.01,297.06,297.07,297.1.ccls.	US-PGPUB;	12:52
) and (wafer or microelectronic or semiconductor))	EPO; JPO;	
		and ((chuck or (wafer adj support) or platen or	DERWENT	
		platform or support) with (adjustable or compliant or		
		resilient or deformable or tiltable))		
<u>.</u>	12	(204/\$.ccls. and ((chuck or (wafer adj support) or	USPAT;	2004/02/13
	1	platen or platform or support) near (adjustable or	US-PGPUB;	12:54
		compliant or resilient or deformable or tiltable or	EPO; JPO;	
		conformable or conforming))) and (wafer or	DERWENT	
		microelectronic or semiconductor)		
_	2559	427/58,123.ccls.	USPAT;	2004/02/13
			US-PGPUB;	13:40
			EPO; JPO;	
			DERWENT;	
		· ·	IBM_TDB	
-	2	427/58,123.ccls. and ((chuck or (wafer adj support)	USPAT;	2004/02/13
		or platen or platform or support) near (adjustable or	US-PGPUB;	13:41
		compliant or resilient or deformable or tiltable or	EPO; JPO;	
		conformable or conforming))	DERWENT	
-	2	427/58,123.ccls. and ((chuck or (wafer adj support)	USPAT;	2004/02/13
		or platen or platform or support) near (adjustable or	US-PGPUB;	13:41
		compliant or resilient or deformable or tiltable or	EPO; JPO;	
		conformable or conforming or tilt))	DERWENT	
-	3	438/584,674,687,689.ccls. and ((chuck or (wafer adj	USPAT:	2004/02/13
		support) or platen or platform or support) near	U5-PGPUB;	13:41
		(adjustable or compliant or resilient or deformable or	EPO; JPO;	
		tiltable or conformable or conforming or tilt))	DERWENT	
-	112	414/779.ccls.	USPAT;	2004/02/13
			US-PGPUB;	13:54
			EPO; JPO;	
•			DERWENT	